



Material Content Data Sheet



Sales Product Name		BAR 89-02LRH E6327		Issued		4. March 2019		
MA#		MA005097554						
Package		PG-TSLP-2-7		Weight*		0.52 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	non noble metal	tin	7440-31-5	0.001	0.12		1198	
	noble metal	gold	7440-57-5	0.002	0.46		4650	
	inorganic material	silicon	7440-21-3	0.029	5.67	6.25	56734	62582
leadframe	non noble metal	nickel	7440-02-0	0.100	19.37	19.37	193709	193709
wire	noble metal	gold	7440-57-5	0.006	1.13	1.13	11313	11313
encapsulation	inorganic material	antimonytrioxide	1309-64-4	0.000	0.03		348	
	organic material	carbon black	1333-86-4	0.004	0.70		6951	
	plastics	epoxy resin	-	0.049	9.38		93842	
	inorganic material	silicondioxide	60676-86-0	0.307	59.42	69.53	593977	695118
leadfinish	noble metal	gold	7440-57-5	0.010	1.86	1.86	18639	18639
plating	noble metal	gold	7440-57-5	0.010	1.86	1.86	18639	18639
*deviation	< 10%			Sum in total:		100.00		1000000

Important Remarks:

1. Infineon Technologies AG provides full material declaration based on information provided by third parties and has taken and continues to take reasonable steps to provide representative and accurate information.
2. Infineon Technologies AG and Infineon Technologies AG suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.
3. All statements are based on our present knowledge, are provided 'as is' and may be subject to change at any time due to technical requirements and development without notification.

This product is in compliance with EU Directive 2015/863/EU amending Annex II to EU Directive 2011/65/EU (RoHS) and does not use any exemption

Company	Infineon Technologies AG
Address	81726 München
Internet	www.infineon.com